

## PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT												
NATURE OF CONVEYANCE:	ASSIGNMENT												
CONVEYING PARTY DATA													
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Motoki Tomizawa</td> <td>02/21/2013</td> </tr> <tr> <td>Takao Okochi</td> <td>02/21/2013</td> </tr> <tr> <td>Tomoki Tanaka</td> <td>02/21/2013</td> </tr> <tr> <td>Naomi Kida</td> <td>02/25/2013</td> </tr> <tr> <td>Yuji Oida</td> <td>02/21/2013</td> </tr> </tbody> </table>		Name	Execution Date	Motoki Tomizawa	02/21/2013	Takao Okochi	02/21/2013	Tomoki Tanaka	02/21/2013	Naomi Kida	02/25/2013	Yuji Oida	02/21/2013
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<table border="1"> <tr> <td>Name:</td> <td>UNITIKA LTD.</td> </tr> <tr> <td>Street Address:</td> <td>50, Higashi-Hommachi 1-chome</td> </tr> <tr> <td>City:</td> <td>Amagasaki-shi, Hyogo</td> </tr> <tr> <td>State/Country:</td> <td>JAPAN</td> </tr> <tr> <td>Postal Code:</td> <td>660-0824</td> </tr> </table>		Name:	UNITIKA LTD.	Street Address:	50, Higashi-Hommachi 1-chome	City:	Amagasaki-shi, Hyogo	State/Country:	JAPAN	Postal Code:	660-0824		
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PROPERTY NUMBERS Total: 1													
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CORRESPONDENCE DATA													
Fax Number:	6098961469												
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>													
Phone:	609-896-3600												
Email:	ipdocket@foxrothschild.com												
Correspondent Name:	FOX ROTHSCHILD LLP PRINCETON PIKE CORPOR												

OP \$40.00 13813904

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NAME OF SUBMITTER:	Miyuki Shimizu
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Signature:	/Miyuki Shimizu/
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Date:	06/11/2013
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Total Attachments: 3 source=Assignment#page1.tif source=Assignment#page2.tif source=Assignment#page3.tif
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## ASSIGNMENT OF INVENTION

In consideration of the payment by ASSIGNEEs to ASSIGNORs of the sum of One Dollar (\$1.00) and for other good and valuable consideration, the receipt of which is hereby acknowledged,

### ASSIGNORs:

Name	Address
Motoki Tomizawa	c/o NIPPON ESTER CO., LTD., Okazaki Plant, 4-1, Hinakitamachi, Okazaki-Shi, Aichi, 444-8511, JAPAN
Takao Okochi	c/o NIPPON ESTER CO., LTD., Okazaki Plant, 4-1, Hinakitamachi, Okazaki-Shi, Aichi, 444-8511, JAPAN
Tomoki Tanaka	c/o NIPPON ESTER CO., LTD., Okazaki Plant, 4-1, Hinakitamachi, Okazaki-Shi, Aichi, 444-8511, JAPAN
Naomi Kida	c/o NIPPON ESTER CO., LTD., Okazaki Plant, 4-1, Hinakitamachi, Okazaki-Shi, Aichi, 444-8511, JAPAN
Yuji Oida	c/o NIPPON ESTER CO., LTD., Okazaki Plant, 4-1, Hinakitamachi, Okazaki-Shi, Aichi, 444-8511, JAPAN

hereby sell, assign and transfer to:

### ASSIGNEE:

Name	Address
UNITIKA LTD.	50, Higashi-Hommachi 1-chome, Amagasaki-shi, Hyogo, 660-0824, JAPAN
NIPPON ESTER CO., LTD.	4-1, Hinakitamachi, Okazaki-shi, Aichi, 444-8511, JAPAN

and the successors, assigns and legal representatives of the ASSIGNEE, entire right, title and interest for the United States and its territorial possessions, and in all foreign countries, including all rights to claim priority, in and to the invention entitled:

Resin Composition Containing Copolymerized Polyester Resin

invented by Tomizawa et al. and which is found in:

- ☒ the U.S. patent application executed on even date herewith;
- ☐ the U.S. patent application executed on
- ☐ the U.S. patent application no.: filed:
- ☐ the International Application no. filed:
- ☐ the U.S. patent no. issued on ;

and, in and to all Letters Patent, both foreign and domestic, to be obtained for said invention by the aforesaid U.S. patent application, and in and to all Non-Provisional and International Applications claiming priority therefrom, and all Letters Patent, both foreign and domestic, to

be obtained for said invention by the aforesaid Non-Provisional and International Applications claiming priority therefrom, and all continuation, division, renewal, continuation-in-part or substitute of said Non-Provisional U.S. Patent Applications, and as to Letters Patent and any reissue or re-examination thereof, and to any legal equivalent thereof in a foreign country, including, the right to apply for patents and inventor certificates in respect thereof, the right to claim priority, and all patents, patents of addition, utility models, patents of importation, revalidation patents and inventor certificates which may be granted throughout the world in respect of the invention.

ASSIGNORS hereby authorize ASSIGNEES or their legal representative to insert in this instrument the filing date and serial number of said application or any other information that may be necessary or desirable in order to comply with the rules of the U.S. Patent and Trademark Office for the recordation of this document.

ASSIGNORS hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment.

ASSIGNORS further covenant and agree that ASSIGNEES will, upon their request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to ASSIGNORS, and that ASSIGNORS will, at ASSIGNEES' expense, testify as to the same in any interference, litigation or proceeding related thereto and will promptly execute and deliver to ASSIGNEES, their assigns or their legal representatives, without further or additional consideration, any and all papers, instruments or affidavits required, render all necessary assistance, and do such additional acts as ASSIGNEES may deem necessary or desirable, to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the purposes thereof.

ASSIGNORS hereby authorize and request the Commissioner of Patents and Trademarks to issue any and all United States Letters Patent referred to above to ASSIGNEES of the entire right, title and interest in and to the same, for ASSIGNEES sole use and benefit, and for the use and benefit of ASSIGNEES legal representatives and successors, to the full end of the term for which such Letters Patent may be granted, as fully and entirely as the same would have been held by ASSIGNORS had this assignment and sale not been made.

The parties agree that the foregoing covenants and obligations shall bind and inure to the benefit of the heirs, assigns and legal representatives of both parties.

Date: February 21, 2013

Signature: Motoki Tomizawa  
Motoki Tomizawa

Date: February 21, 2013

Signature: Takao Okochi  
Takao Okochi

Date: February 21, 2013

Signature: Tomoki Tanaka  
Tomoki Tanaka

Date: February 25, 2013

Signature: Naomi Kida  
Naomi Kida

Date: February 21, 2013

Signature: Yuji Oida  
Yuji Oida